

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

3/19/02  
Applicant : Detlef Weber Art Unit : Unknown  
Serial No. : Not assigned yet Examiner : Unknown  
Filed : Herewith  
Title : METALLIZATION ARRANGEMENT FOR SEMICONDUCTOR STRUCTURE  
AND CORRESPONDING FABRICATION METHOD

Commissioner for Patents  
Washington, D.C. 20231

## PRELIMINARY AMENDMENT

Prior to examination, please amend this application as follows:

### In the specification:

On page 1, line 1, delete "Description"

On page 1, line 5, insert - **BACKGROUND--**

92 On page 2, line 24, insert --SUMMARY--

On page 2, delete the paragraph that begins on line 28.

On page 3, line 6, delete the paragraph beginning on line 6.

93 On page 4, line 18, insert **BRIEF DESCRIPTION OF THE FIGURES--**

On page 4, line 31, insert --DETAILED DESCRIPTION--

### In the claims:

Please cancel claims 1-6 and claims 7-13

Please consider the following new claims 14-20 and 21-27

CERTIFICATE OF MAILING BY EXPRESS MAIL

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